DATA SHEET

OCMOS FET PS7112-1A,PS7112L-1A

Solid State Relay

6-PIN DIP, 200 mA CONTINUOUS LOAD CURRENT 1-ch Optical Coupled MOS FET

DESCRIPTION

NEC

The PS7112-1A and PS7112L-1A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity.

The PS7112L-1A has a surface mount type lead.

***** FEATURES

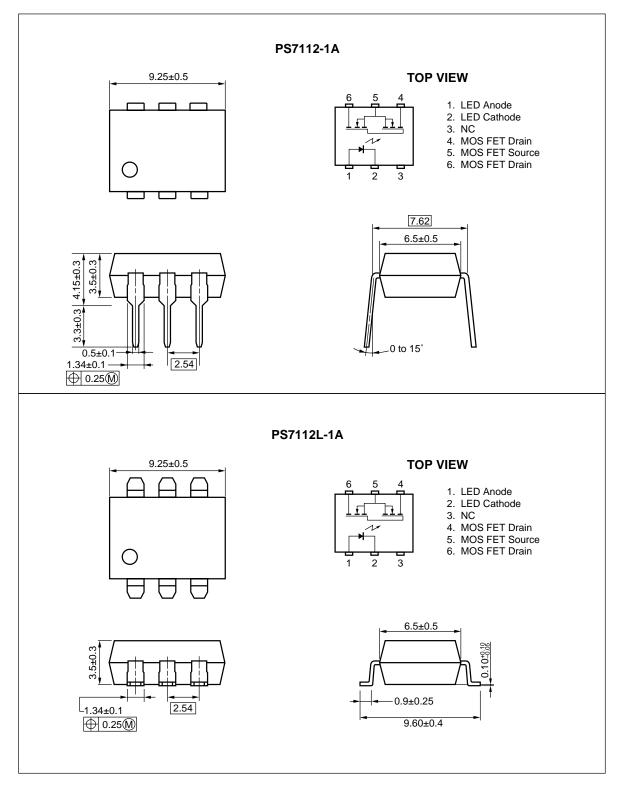
- 1 channel type (1 a output)
- Low LED operating current (IF = 2 mA)
- Designed for AC/DC switching line changer
- Small package (6-pin DIP)
- Low offset voltage
- PS7112L-1A: Surface mount type
- UL approved: File No. E72422 (S)
- BSI approved: No. 8245/8246
- CSA approved: No. CA 101391

APPLICATIONS

- Exchange equipment
- Measurement equipment
- FA/OA equipment

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PACKAGE DIMENSIONS (in millimeters)



★ ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number ^{*1}
PS7112-1A	6-pin DIP	Magazine case 50 pcs	PS7112-1A
PS7112L-1A			PS7112L-1A
PS7112L-1A-E3		Embossed Tape 1 000 pcs/reel	
PS7112L-1A-E4			

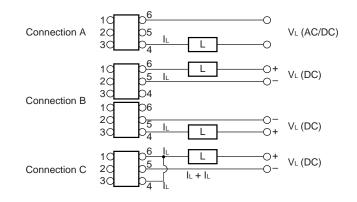
*1 For the application of the Safety Standard, following part number should be used.

	ABSOLUTE MAXIMUM RAT	INGS (TA = 25 °C,	, unless otherwise specified)
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	Parameter			Symbol	Ratings	Unit
	Diode	Forward Current (D	C)	lf	50	mA
		Reverse Voltage		VR	5.0	V
		Power Dissipation		PD	50	mW
		Peak Forward Current ¹		IFP	1	А
	MOS FET	ET Break Down Voltage Continuous Load Current ⁻² Connection B Connection C Pulse Load Current ⁻³ (AC/DC Connection) Power Dissipation		VL	100	V
ł				١L	200	mA
					250	
					400	
ł				Ilp	400	mA
				PD	560	mW
	Isolation Voltage ⁴ Total Power Dissipation			BV	1 500	Vr.m.s.
				Ρτ	610	mW
	Operating Ambient Temperature			TA	-40 to +80	°C
	Storage Temperature			Tstg	-40 to +100	°C

*1 PW = 100 μ s, Duty Cycle = 1 %

*2 Conditions: IF \geq 2 mA. The following types of load connections are available.



*3 PW = 100 ms, 1 shot

*4 AC voltage for 1 minute at TA = 25 °C, RH = 60 % between input and output

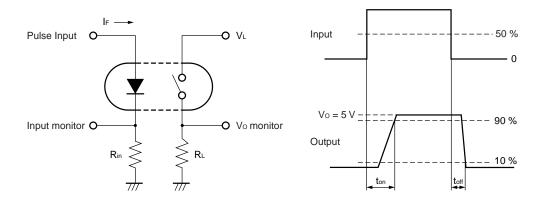
RECOMMENDED OPERATING CONDITIONS (TA = 25 °C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	IF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

* ELECTRICAL CHARACTERISTICS (TA = 25 °C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode Forward Voltage		VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	Ir	V _R = 5 V			5.0	μA
MOS FET Off-state Leakage Current ILoff VD = 100 V		V _D = 100 V		0.03	1.0	μA	
	Output Capacitance	Cout	$V_D = 0 V, f = 1 MHz$		57		pF
Coupled	LED On-state Current	IFon	l∟ = 200 mA			2.0	mA
	On-state Resistance	Ron1	IF = 10 mA, IL = 10 mA		3.0	6.0	Ω
		Ron2	$I_F = 10 \text{ mA}, I_L = 200 \text{ mA}, t \le 10 \text{ ms}$				
	Turn-on Time [™]	ton	I_{F} = 10 mA, Vo = 5 V, PW \geq 10 ms		0.1	0.4	ms
	Turn-off Time [™]	toff			0.03	0.2	
	Isolation Resistance	Ri-o	VI-O = 1.0 kVDC	10 ⁹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		1.1		pF

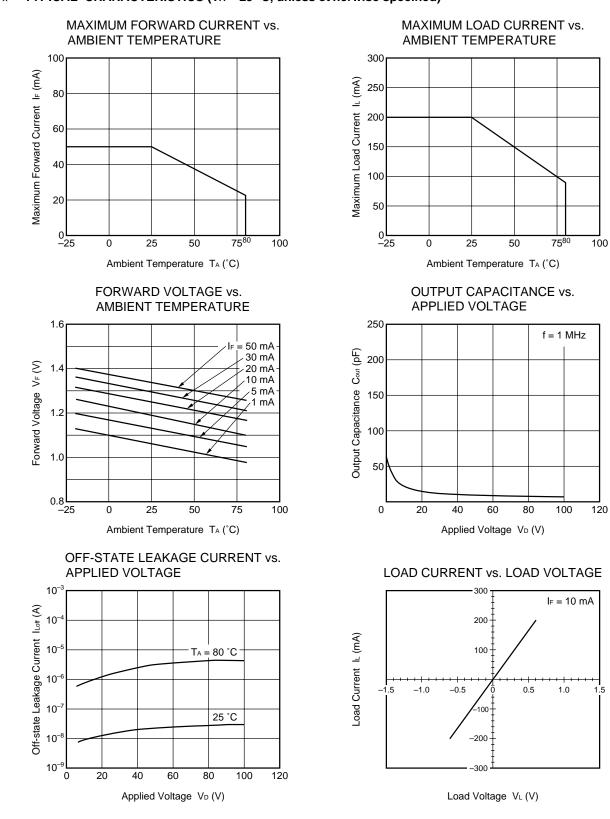
*1 Test Circuit for Switching Time



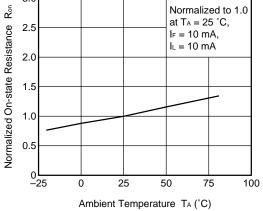
1.5

TYPICAL CHARACTERISTICS (TA = 25 °C, unless ot herwise specified) *

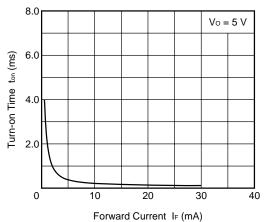
NEC



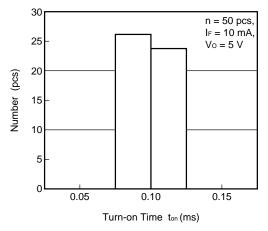
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



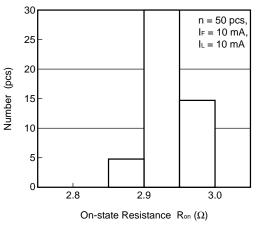
TURN-ON TIME vs. FORWARD CURRENT



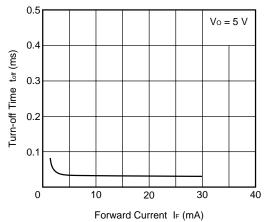
TURN-ON TIME DISTRIBUTION



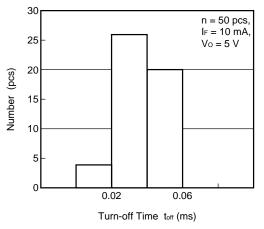
ON-STATE RESISTANCE DISTRIBUTION



TURN-OFF TIME vs. FORWARD CURRENT



TURN-OFF TIME DISTRIBUTION



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Normalized to 1.0

75

100

at $T_A = 25$ °C, I_F = 10 mA,

Vo = 5 V

NORMALIZED TURN-OFF TIME vs.

AMBIENT TEMPERATURE

25

Ambient Temperature TA (°C)

50

3.0

2.5

2.0

1.5

1.0

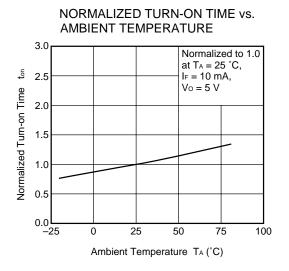
0.5

0.0

0

toff

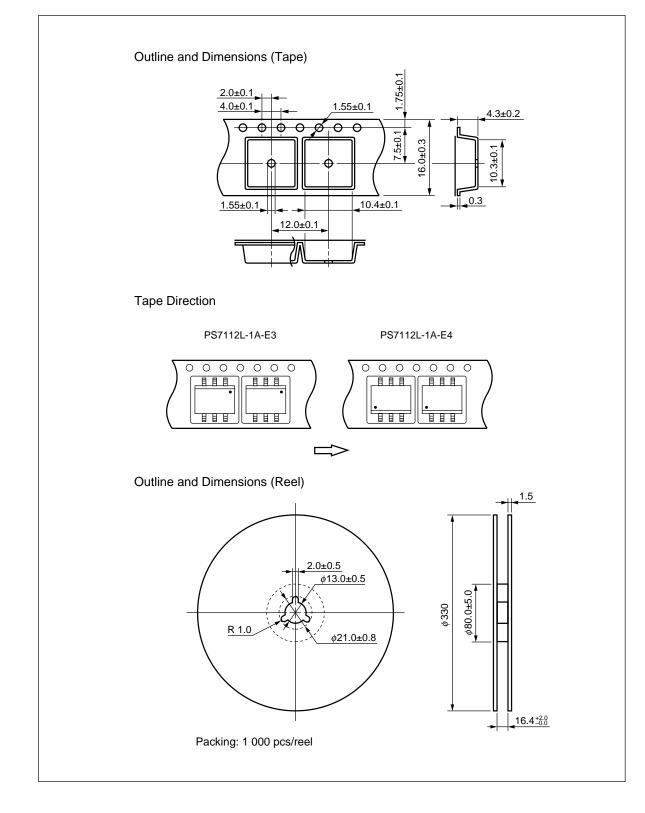
Normalized Turn-off Time



Remark The graphs indicate nominal characteristics.

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***** TAPING SPECIFICATIONS (in millimeters)



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RECOMMENDED SOLDERING CONDITIONS

- (1) Infrared reflow soldering
 - Peak reflow temperature
 235 °C (package surface temperature)

Two

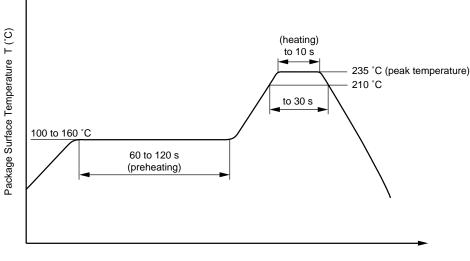
- Time of temperature higher than 210 °C
- Number of reflows
- Flux

*

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

Recommended Temperature Profile of Infrared Reflow

30 seconds or less





(2) Dip soldering

Temperature 260 °C or below (molten solder temperature)

- Time
- 10 seconds or less
- Number of times One
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

(3) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

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[MEMO]

CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.

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